3.5x2.8mm SURFACE MOUNT LED LAMP

Part Number: AA3528VRCBS/A Cyan

ATTENTION OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE DEVICES

Features

- Single color.
- Suitable for all SMT assembly and solder process.
- Available on tape and reel.
- Ideal for backlighting.
- Package : 1500pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

Description

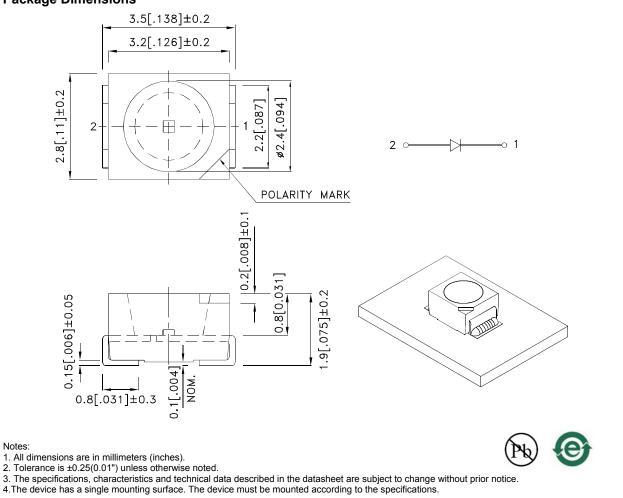
The source color devices are made with InGaN Light Emitting Diode.

Static electricity and surge damage the LEDS.

It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.

All devices, equipment and machinery must be electrically grounded.

Package Dimensions

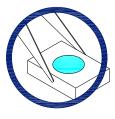


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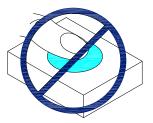
Handling Precautions

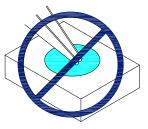
Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although its characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force. As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might leads to damage and premature failure of the LED.

1. Handle the component along the side surfaces by using forceps or appropriate tools.



2. Do not directly touch or handle the silicone lens surface. It may damage the internal circuitry.

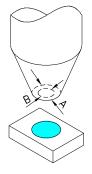




3. Do not stack together assembled PCBs containing exposed LEDs. Impact may scratch the silicone lens or damage the internal circuitry.



- 4. The outer diameter of the SMD pickup nozzle should not exceed the size of the LED to prevent air leaks. The inner diameter of the nozzle should be as large as possible.
- 5. A pliable material is suggested for the nozzle tip to avoid scratching or damaging the LED surface during pickup.
- 6. The dimensions of the component must be accurately programmed in the pick-and-place machine to insure precise pickup and avoid damage during production.



Selection Guide						
Part No.	Dice	Lens Type	lv (mcd) [2] @ 20mA Min. Typ.		Viewing Angle [1]	
					201/2	
AA3528VRCBS/A	Cyan (InGaN)	WATER CLEAR	900	1400	120°	

Notes: 1. θ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value. 2. Luminous intensity/ luminous Flux: +/-15%.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
VF [1]	Forward Voltage	Cyan	3.3	4.0	V	IF=20mA
IR	Reverse Current	Cyan		50	uA	VR = 5V
x [2]	Chromoticity Coordinates	Guan	0.19			
y [2]	Chromaticity Coordinates	Cyan	0.37			
С	Capacitance	Cyan	100		pF	VF=0V;f=1MHz

Notes:

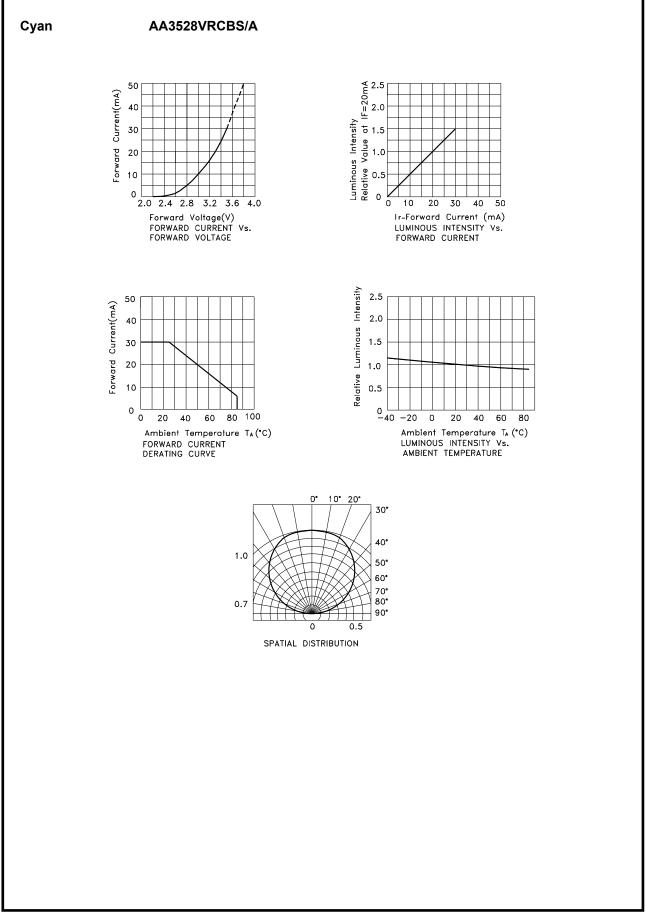
1. Forward Voltage: +/-0.1V.

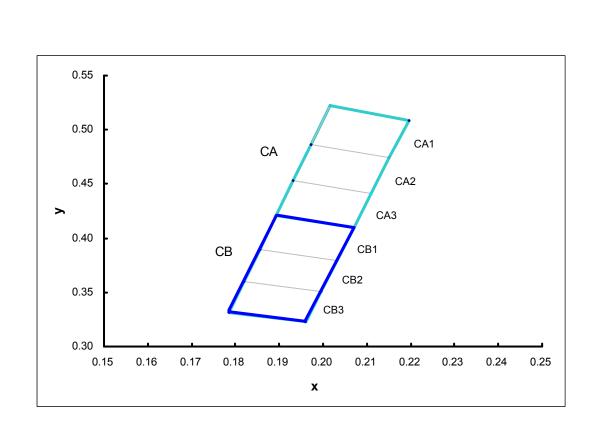
2. Measurement tolerance of the chromaticity coordinates is $\pm 0.01.$

Absolute Maximum Ratings at TA=25°C

Parameter	Cyan	Units	
Power dissipation	120	mW	
DC Forward Current	30	mA	
Peak Forward Current [1]	100	mA	
Reverse Voltage	5	V	
Operating Temperature	-40°C To +85°C		
Storage Temperature	-40°C To +85°C		

Note: 1. 1/10 Duty Cycle, 0.1ms Pulse Width.





Bin code	x	У	Bin code	x	У
CA1	0.2016	0.5221		0.1894	0.4206
	0.1973	0.4868	CB1	0.1856	0.3897
	0.2152	0.4744		0.2032	0.3794
	0.2195	0.5089		0.2070	0.4097
CA2	0.1973	0.4868	CB2	0.1856	0.3897
	0.1933	0.4530		0.1821	0.3601
	0.2110	0.4413		0.1996	0.3505
	0.2152	0.4744		0.2032	0.3794
	0.1933	0.4530		0.1821	0.3601
CA3	0.1894	0.4206	СВЗ	0.1786	0.3318
	0.2070	0.4097		0.1961	0.3228
	0.2110	0.4413		0.1996	0.3505

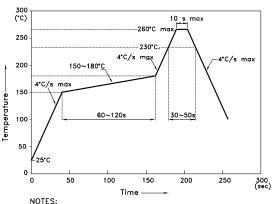
Notes:

Shipment may contain more than one chromaticity regions. Orders for single chromaticity region are generally not accepted. Measurement tolerance of the chromaticity coordinates is ± 0.01 .

AA3528VRCBS/A

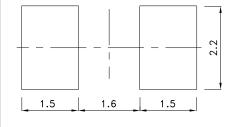
Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

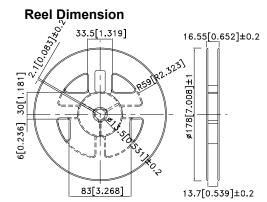
Reflow Soldering Profile For Lead-free SMT Process.



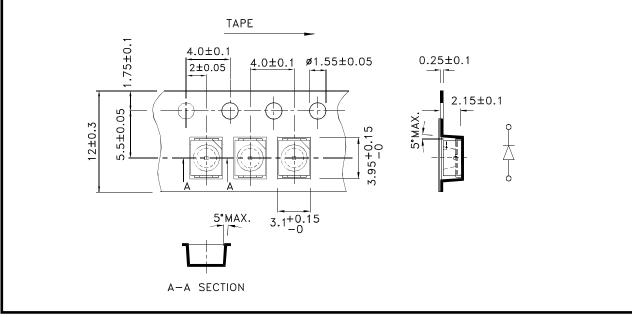
NOTES: 1.We recommend the reflow temperature $245^{\circ}C(+/-5^{\circ}C)$. The maximum soldering temperature should be limited to 260°C. 2.Don't cause stress to the epoxy resin while it is exposed to high temperature. 3.Number of reflow process shall be 2 times or less.







Tape Dimensions (Units : mm)



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